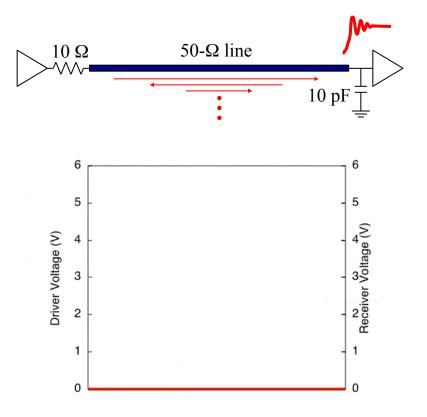


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Outline

- What are they?
 - L = Inductance
 - I® = Current Return Path
- Why do we care?
- Common Misconceptions
- How do we control them?
- How do we identify problems?
- Summary



L: What is it?

- Various kinds: *loop*, *mutual*, external, internal, kinetic, self, *partial*, self partial, mutual partial, partial mutual, ...
- Definition of inductance for closed loops:

$$L_{1} = \frac{\Psi_{1}}{I_{1}} \qquad M_{21} = \frac{\Psi_{21}}{I_{1}}$$

- External, internal, kinetic
- Self, *partial*, self partial, mutual partial, partial mutual



L: Recommended References

- Book:
 - Clayton Paul, "Introduction to Electromagnetic Compatibility"
- Paper:
 - Al Ruehli, "Inductance Calculations in a Complex Integrated Circuit Environment," IBM Journal of R&D, September 1972.
- Articles:
 - Bruce Archambeault, "Decoupling Capacitor Connection Inductance," IEEE EMCS Newsletter, Spring 2009
 - Bruce Archambeault, "Part II: Resistive vs. Inductive Return Current Paths," IEEE EMCS Newsletter, Fall 2008



L: Why do we care?

- Affects signal quality, crosstalk, EMI.
- Voltage Drop/Fluctuation

$$V_{L} = L \frac{dI_{L}}{dt} \qquad \frac{+ V_{L} - V_{L}}{I_{I}}$$

Crosstalk & EMI

$$V_2 = M_{21} \frac{dI_1}{dt}$$
 $M_{21} = L_{21}$

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Why do we care?

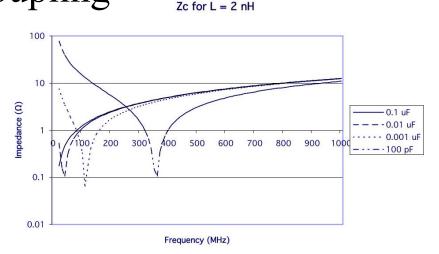
- Transmission Line Discontinuity
 - → Signal Ringing // //



Filtering & Decoupling

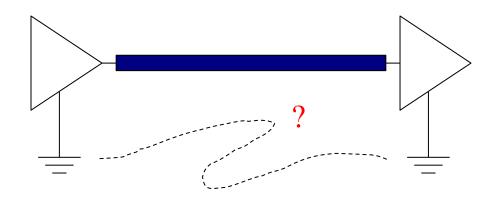
$$- Z_c(f)$$

$$- f_o = \frac{1}{2\pi\sqrt{LC}}$$





IR: What is it?



• Is ground a zero-impedance equipotential surface?

$$-V_G = I_G Z_G = I_G (R_G + j\omega L_G) \neq 0$$

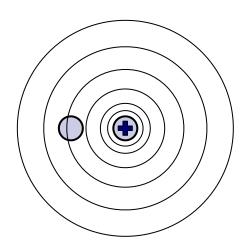


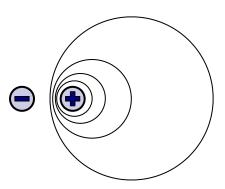
I®: Why do we care?

- Increases current loop area A
 - EMI ↑
- Increases loop inductance L
 - Signal Quality ↓
 - EMI ↑
- Increases mutual inductance M
 - Crosstalk ↑
 - **EMI** ↑
- Increases ground (return) inductance L_G or M_G
 - **EMI** ↑



- Mistake loop L as sum of self inductances (L_{self}) !?
- Overlook the importance of return proximity!?



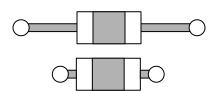


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L: Mounting Inductance







- Increase width.





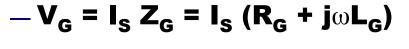
— Think return proximity!

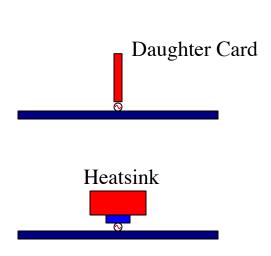


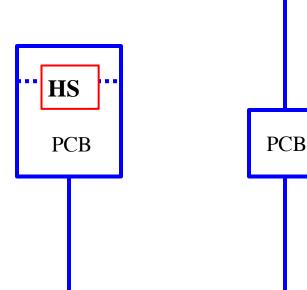


— Think loop inductance!!

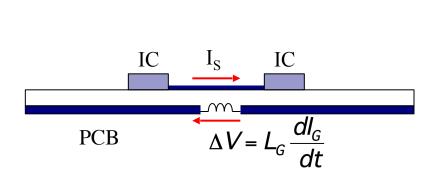
- Ground Drop \propto Self Inductance (L_{Self})!?
 - Ground Drop is a main source of CM radiation!

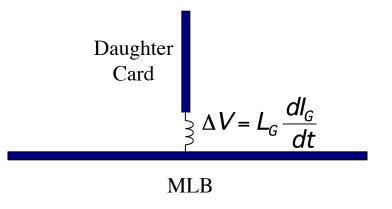


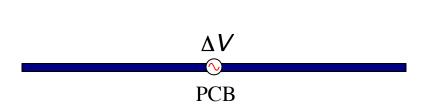


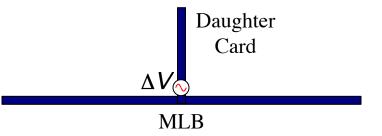


L: $\Delta V = L_G dI_G/dt$





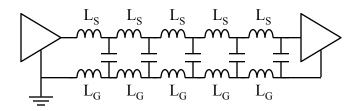






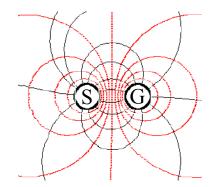
L: Ground Inductance

• Transmission Line: $L_T = L_S + L_G$



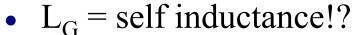
• Ψ_G = magnetic flux around ground conductor

$$L_G = \frac{\Psi_G}{I_G}$$



Magnetic FieldElectric Field

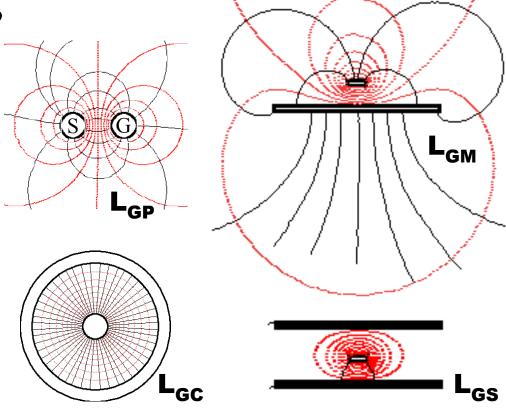
L: $L_G = ?$



- $-L_{G} = M_{G} (DM \rightarrow CM)$
 - Partial inductance
- Pairs (S, P, V, W)

•
$$L_{GP} = L_T/2$$

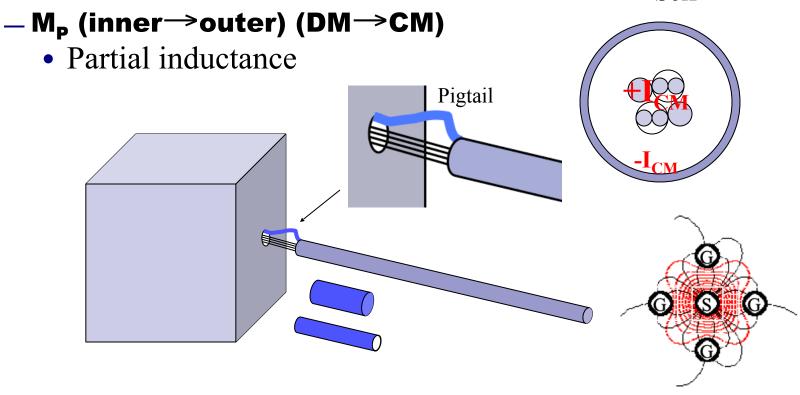
- Microstrip
 - $L_{GM} \ll L_{T}$
- Stripline
 - $L_{GS} \ll L_{GM}$
- Coaxial
 - $L_{GC} \approx 0$



Magnetic Field

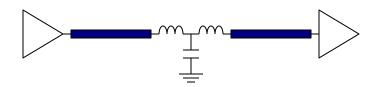
Electric Field

• Pigtail termination is bad because of its L_{Self}!?

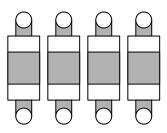




- Smaller is always better!?
 - Excess capacitance causes reflections!



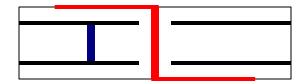
- Inductance parallels down like resistors!?
 - Don't forget M!
 - Spread out decoupling capacitors!
 - Alternate power/ground pins!

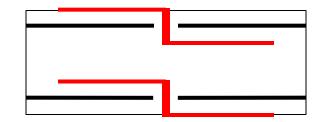


- Overlook mounting inductance vs. component inductance!?
 - Don't spend on expensive low-L filters unless layout has already been optimized.

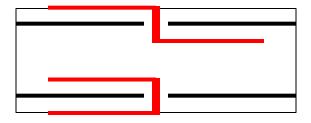


- Via Inductance = $L_{Self}!$?
 - Think loop inductance!





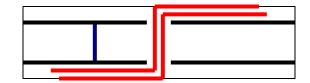
- Overlook the dependence on current distribution!?
 - Current distribution affects inductance!



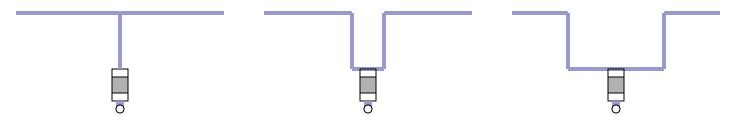


- Overlook the importance of return proximity!?
 - Think separation.
 - Think return proximity!

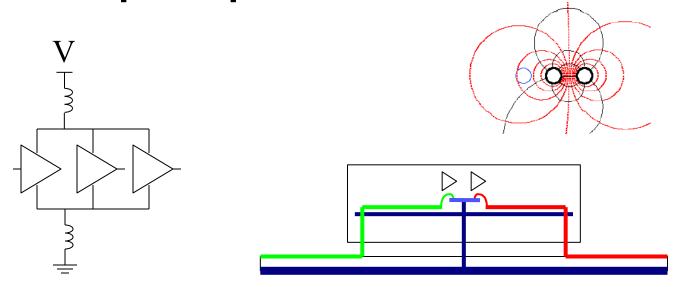




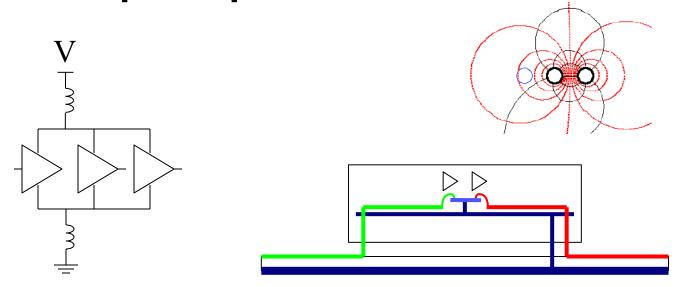
- L_{Self} degrades capacitor performance!?
 - Think mutual inductance!



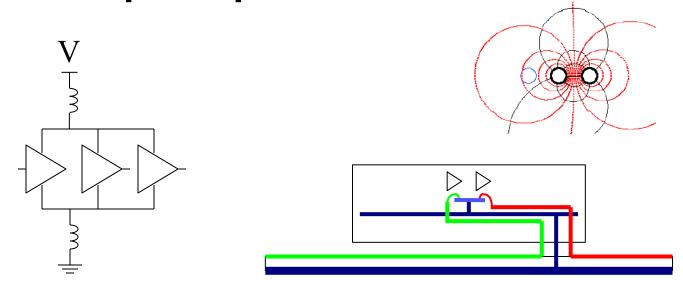
- Ground Bounce & Power Noise $\propto L_{Self}(L_P)$ of Pin!?
 - Think loop-to-loop mutual inductance!



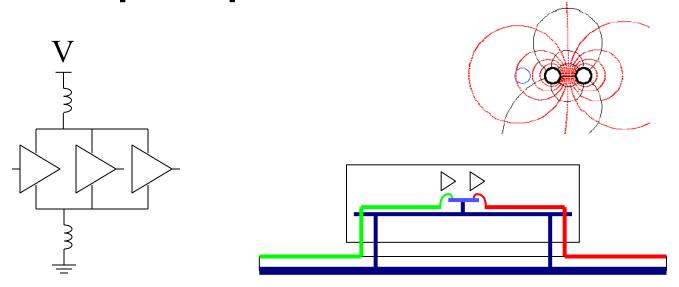
- Ground Bounce & Power Noise $\propto L_{Self}(L_P)$ of Pin!?
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- Ground Bounce & Power Noise $\propto L_{Self}(L_P)$ of Pin!?
 - Think loop-to-loop mutual inductance!



v

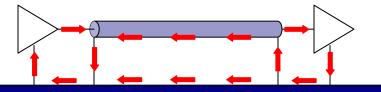
IR: Common Misconceptions

• Signal ground is a current source/sink!?

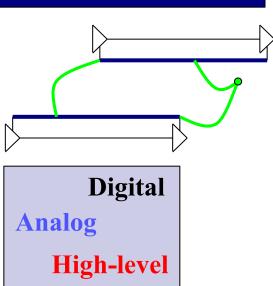


- Ground plane is a zero-impedance equipotential surface!?
 - $-V_G = I_G Z_G = I_G (R_G + j\omega L_G) \neq 0$
 - At kHz: $R_G \gg j\omega L_G$
 - IR drop causes common-impedance coupling.
 - At MHz/GHz: $R_G \ll j\omega L_G$
 - I® affects A, L, M, SI, EMI.

- Current takes the least resistance path!?
 - $Z_G = R_G + j\omega L_G$
 - Think R at $f \le kHz$.
 - Think L at f ≥ MHz!

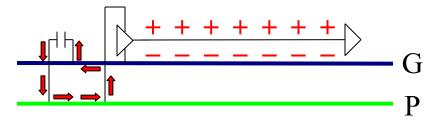


- Current returns along intended paths!?
 - IR drop → common-Z coupling.
 - Current spreads out at $f \le kHz$.
 - Single-point grounding used for:
 - Low-level analog subsystems,
 - High-level noisy subsystems, e.g. motor drivers.

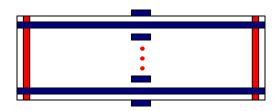


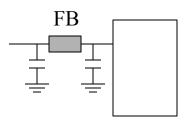


• Current returns through ground but not power!?



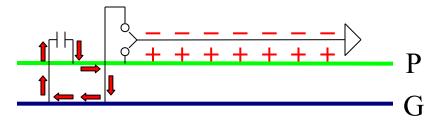
- Ground and power planes are interchangeable!?
 - Ground is connected to chassis, but not power.
 - Power isolation breaks the symmetry.



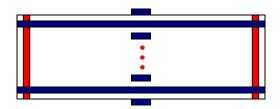


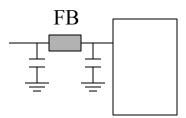


• Current returns through ground but not power!?

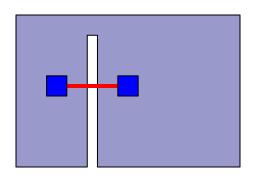


- Ground and power planes are interchangeable!?
 - Ground is connected to chassis, but not power.
 - Power isolation breaks the symmetry.

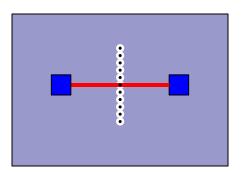




• Overlook horizontal return path!?

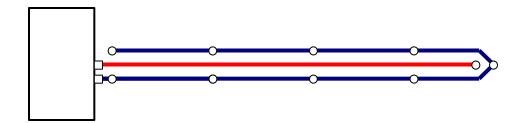


- Traces crossing plane cuts
 - Avoid ground plane cuts.
 - Route around plane cuts.
 - Use stitching capacitors.

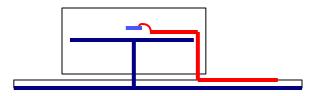


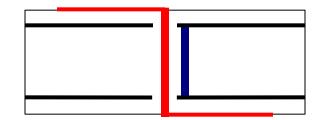
- Overlapping via antipads
 - Stagger vias.
 - Space vias apart.

- Overlook vertical return path!?
 - Trace to Plane



- Plane to Plane

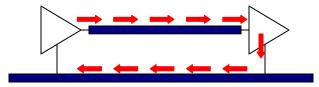




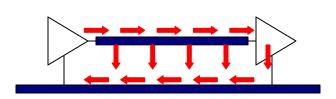


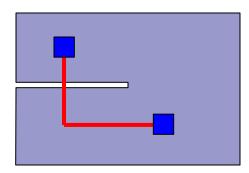
- Overlook cross-board return paths!?
 Avoid discontinuity.
 Provide capacitors.
- Overlook off-board return paths!?

- Current flows in loops.
 - Think of signal path and return path separately!?



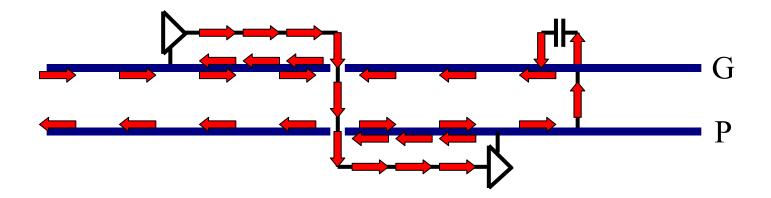
- Current flows in loops, but not this way.
- Current flows in pairs!
 - Signal and return go hand-in-hand.





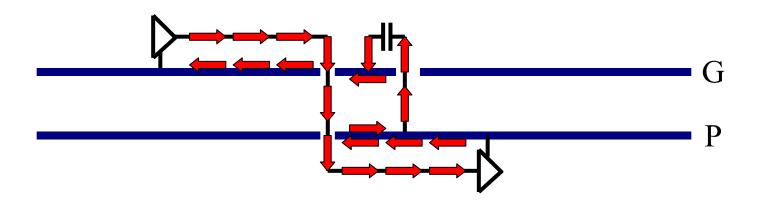


• Trace out the current return path.





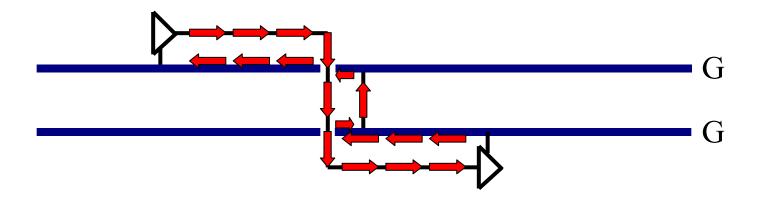
• Trace out the current return path.



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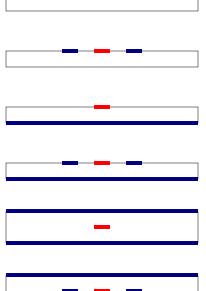
• Trace out the current return path.



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L: How do we control them?

- $L \rightarrow Signal Ringing$
 - Small loop (adjacent return, short, wide).
- $M_{21} \rightarrow Crosstalk$ (Inductive Coupling)
 - Separation, return proximity, twisting, shielding.
- $L_G(M_G) \rightarrow Ground Drop \rightarrow E_{CM}$
 - Coaxial, stripline, microstrip.
 - Small H, large W, away from edge, guard traces.
- $L_C \rightarrow Decoupling$
 - Small loop (short wide traces, adjacent vias).
 - Use multiple capacitors and spread them out.
- $M_C \rightarrow Filtering$
 - Minimize M (eliminate stub, short trace to ground).





IR: How do we control them?

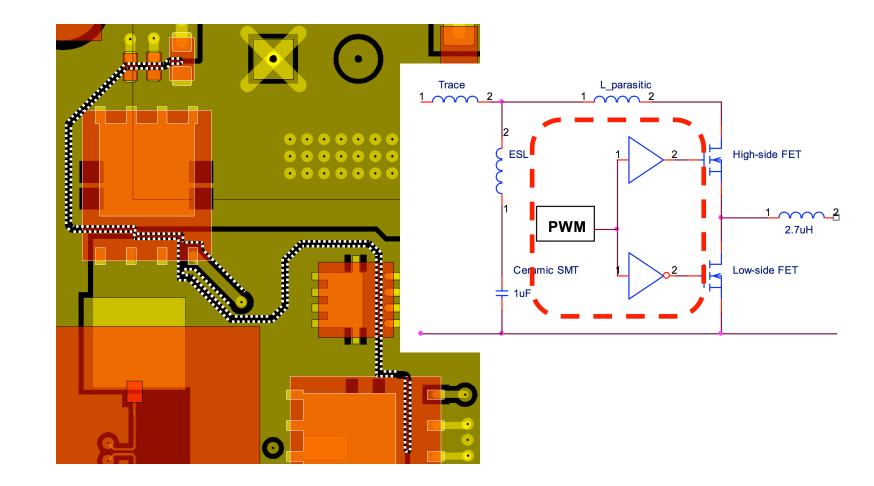
- At kHz: $R_G \gg j\omega L_G$
 - Low-level analog or high-level noisy subsystems
 - Single-point grounding prevents common-Z coupling.
- At MHz/GHz: $R_G \ll j\omega L_G$
 - Horizontal return
 - Use ground planes/grids instead of ground traces.
 - Avoid traces crossing plane cuts.
 - Vertical return
 - Provide adjacent return pins for noisy or susceptible pins.
 - Provide adjacent vias, stitching capacitors as return bridges.
 - Provide sufficient vias for guard traces.

L & IR: How do we identify problems?

Options	Pros	Cons
Fix when Fail	Less design time	Risks: time, cost,
Layout Review	Identify problems early	Labor intensive
Layout Checking Tool	Identify problems quickly Less labor intensive	Report 100's of violations Require expertise & time to identify critical violations
Automated & Customized Layout Checking Tool	Identify problems quickly No setup required Report critical violations	Require automation and customization development

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I®: Tracing and Highlighting





Summary

- L & I® affects signal quality, crosstalk and EMI.
- Inductance (L)
 - Forget self inductance.
 - Think loop, mutual, and partial inductance!
 - Think return proximity!
- Current Return Path (I®)
 - Low f: Current spreads out as $R_g \gg j\omega L_g$.
 - High f: Trace out I® to identify discontinuities.